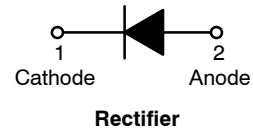


# Schottky Barrier Rectifiers, Surface Mount, 2 A, 20 V - 150 V

## SS22FA - S215FA

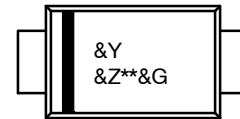
### Features

- Low Power Loss, High Efficiency
- Guard Ring for Overvoltage Protection
- High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- Green Molding Compound
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



**SOD-123FL  
CASE 425AB**

### MARKING DIAGRAM



Band Indicates Cathode

- &Y = Binary Calendar Year Coding Scheme
- &Z = Assembly Plant Code
- \*\* = Specific Device Code  
(see "Top Mark" in the table below)
- &G = Single Digit Weekly Date Code

### ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping <sup>†</sup>
SS22FA	22L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBSS22FA			
SS23FA	23L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBSS23FA			
SS25FA	25L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBSS25FA			
SS29FA	29L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBSS29FA			
S210FA	20L	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBS210FA			
S215FA	2AL	SOD-123FL (Pb-Free)	3000 / Tape & Reel
NRVBS215FA			

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# SS22FA – S215FA

## SPECIFICATIONS

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value						Unit
		SS22FA	SS23FA	SS25FA	SS29FA	S210FA	S215FA	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	20	30	50	90	100	150	V
V <sub>RMS</sub>	RMS Reverse Voltage	14	21	35	63	70	105	V
V <sub>R</sub>	DC Blocking Voltage	20	30	50	90	100	150	V
I <sub>F(AV)</sub>	Average Forward Rectified Current	2						A
I <sub>FSM</sub>	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	50						A
T <sub>J</sub>	Operating Junction Temperature Range	-55 to +125		-55 to +150				°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150						°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) (Note 1)

Symbol	Characteristic	Value	Unit
Ψ <sub>JL</sub>	Junction-to-Lead Thermal Characteristics	16	°C/W
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance	152	°C/W

1. Per JE51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Value						Unit
			SS22FA	SS23FA	SS25FA	SS29FA	S210FA	S215FA	
V <sub>F</sub>	Maximum Instantaneous Forward Voltage (Note 2)	I <sub>F</sub> = 2 A	0.50		0.70	0.85		0.95	V
I <sub>R</sub>	Maximum Reverse Current at Rated V <sub>R</sub>	T <sub>J</sub> = 25°C	0.4			0.1			mA
		T <sub>J</sub> = 100°C	15		10				
		T <sub>J</sub> = 125°C			5				
C <sub>J</sub>	Typical Junction Capacitance	V <sub>R</sub> = 4 V, f = 1 MHz	120		93	62		48	pF
T <sub>rr</sub>	Typical Reverse Recovery Time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>RR</sub> = 0.25 A	10		9	7		13	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse test with PW = 300 μs, 1% duty cycle.

# SS22FA - S215FA

## TYPICAL PERFORMANCE CHARACTERISTICS

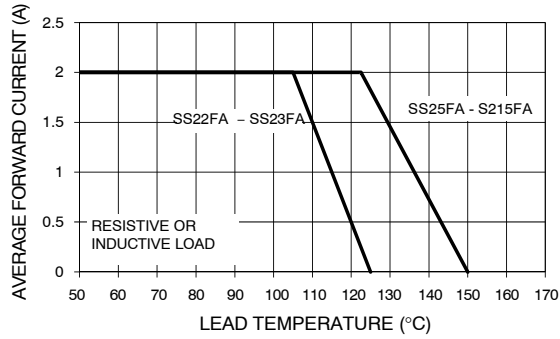


Figure 1. Forward Current Derating Curve

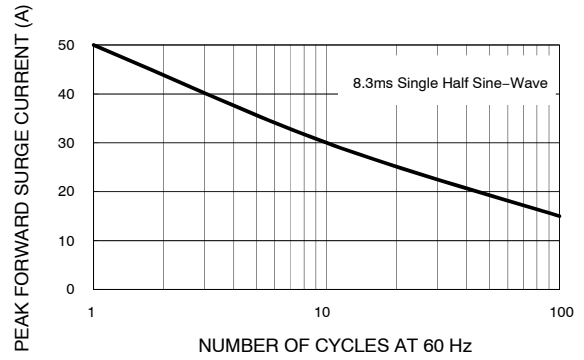


Figure 2. Maximum Non-Repetitive Forward Surge Current

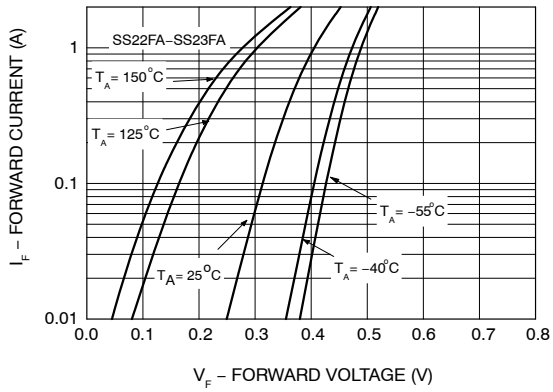


Figure 3. Typical Forward Characteristics

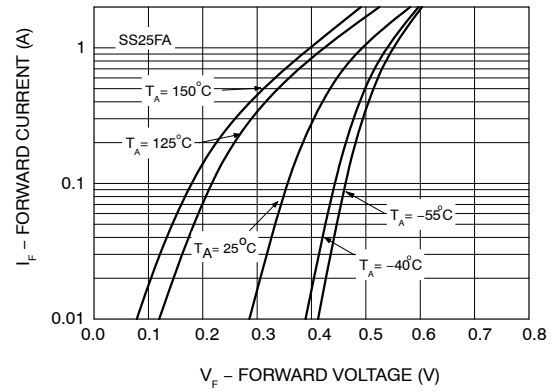


Figure 4. Typical Forward Characteristics

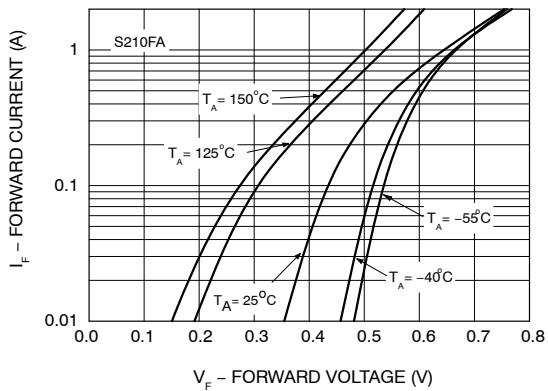


Figure 5. Typical Forward Characteristics

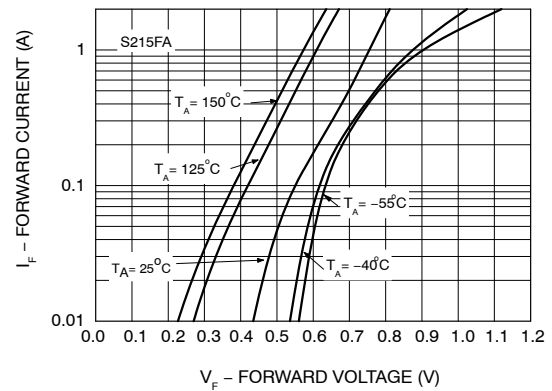


Figure 6. Typical Forward Characteristics

# SS22FA - S215FA

## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

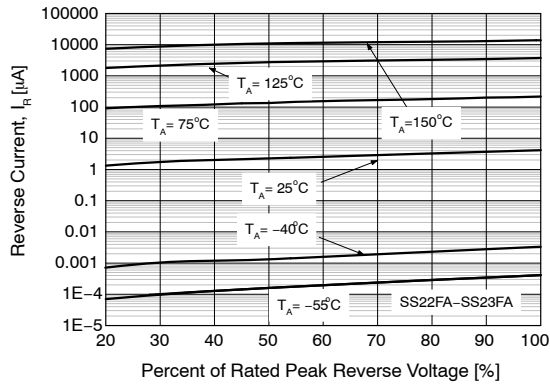


Figure 7. Typical Reverse Characteristics

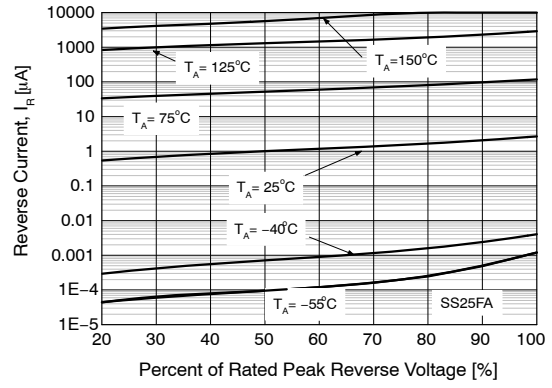


Figure 8. Typical Reverse Characteristics

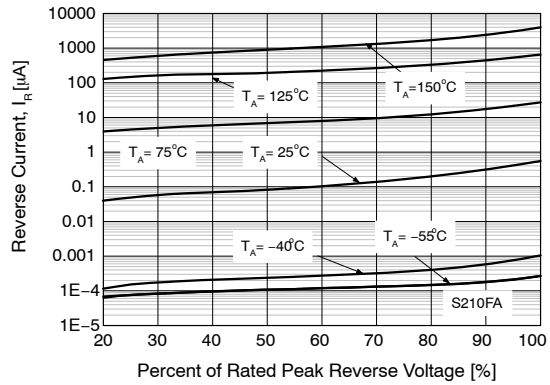


Figure 9. Typical Reverse Characteristics

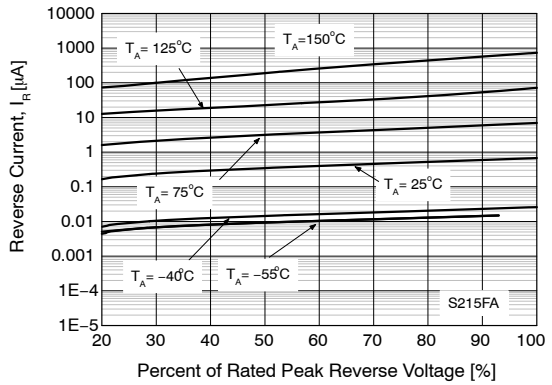


Figure 10. Typical Reverse Characteristics

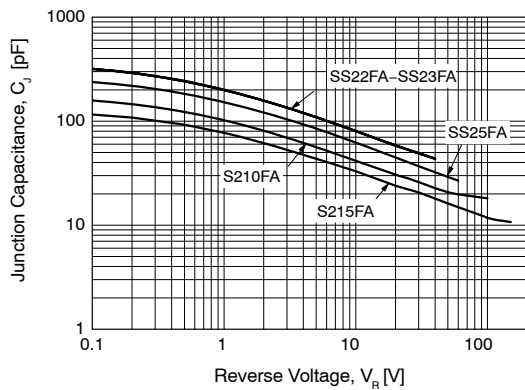


Figure 11. Typical Junction Capacitance

**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

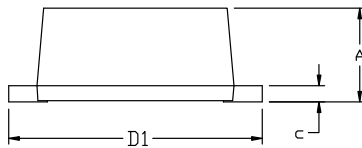


**SOD-123FA**  
**CASE 425AB**  
**ISSUE A**

DATE 11 AUG 2022



TOP VIEW



FRONT VIEW



BOTTOM VIEW

NOTES:

1. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND THE BAR PROTRUSIONS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	1.23	1.33	1.43
b	0.80	1.00	1.20
c	0.16	0.23	0.30
D	2.70	2.80	2.90
D1	3.40	3.60	3.80
E	1.70	1.80	1.90
He	2.45	---	2.60
L	0.35	0.60	0.85



**RECOMMENDED MOUNTING FOOTPRINT\***

\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

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